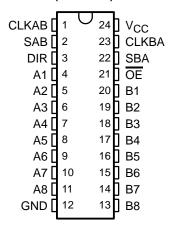
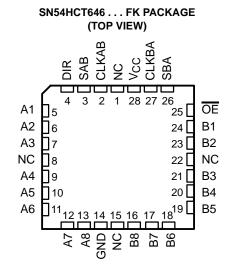
- Operating Voltage Range of 4.5 V to 5.5 V
- Low Power Consumption, 80-μA Max I_{CC}
- Typical t_{pd} = 12 ns
- ±6-mA Output Drive at 5 V
- Low Input Current of 1 μA Max
- Inputs Are TTL-Voltage Compatible

SN54HCT646...JT OR W PACKAGE SN74HCT646...DW OR NT PACKAGE (TOP VIEW)



- Independent Registers for A and B Buses
- Multiplexed Real-Time and Stored Data
- True Data Paths
- High-Current 3-State Outputs Can Drive Up To 15 LSTTL Loads



NC – No internal connection

description/ordering information

The 'HCT646 devices consist of bus-transceiver circuits with 3-state outputs, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'HCT646 devices.

Output-enable (\overline{OE}) and direction-control (DIR) inputs control the transceiver functions. In the transceiver mode, data present at the high-impedance port can be stored in either or both registers.

ORDERING INFORMATION

TA	PACKAC	3E†	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	PDIP – NT Tube		SN74HCT646NT	SN74HCT646NT
–40°C to 85°C	SOIC - DW	Tube	SN74HCT646DW	HCT646
	SOIC - DW	Tape and reel	SN74HCT646DWR	HC1040
	CDIP – JT	Tube	SNJ54HCT646JT	SNJ54HCT646JT
–55°C to 125°C	CFP – W	Tube	SNJ54HCT646W	SNJ54HCT646W
	LCCC – FK	Tube	SNJ54HCT646FK	SNJ54HCT646FK

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



SN54HCT646, SN74HCT646 OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

SCLS178C - MARCH 1984 - REVISED MARCH 2003

description/ordering information (continued)

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. DIR determines which bus receives data when \overline{OE} is active (low). In the isolation mode (\overline{OE} high), A data can be stored in one register and/or B data can be stored in the other register.

When an output function is disabled, the input function still is enabled and can be used to store data. Only one of the two buses, A or B, can be driven at a time.

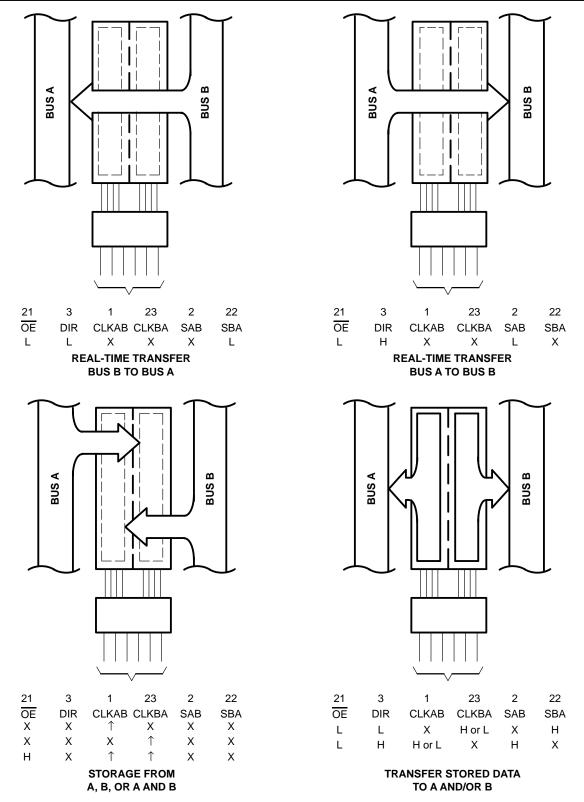
To ensure the high-impedance state during power up or power down, $\overline{\text{OE}}$ should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTION TABLE

		INP	UTS			DAT	A I/O	OPERATION OR FUNCTION
ŌĒ	DIR	CLKAB	CLKBA	SAB	SBA	A1-A8	B1-B8	OPERATION OR FUNCTION
Х	Х	1	Х	Х	Х	Input	Unspecified [†]	Store A, B unspecified [†]
X	X	Χ	↑	Χ	Χ	Unspecified [†]	Input	Store B, A unspecified [†]
Н	Х	1	↑	Х	Х	Input	Input	Store A and B data
Н	Х	H or L	H or L	Χ	Χ	Input disabled	Input disabled	Isolation, hold storage
L	L	Х	Х	Х	L	Output	Input	Real-time B data to A bus
L	L	Х	H or L	Χ	Н	Output	Input	Stored B data to A bus
L	Н	Х	Х	L	Х	Input	Output	Real-time A data to B bus
L	Н	H or L	Χ	Н	Χ	Input	Output	Stored A data to B bus

[†] The data-output functions can be enabled or disabled by various signals at $\overline{\text{OE}}$ and DIR. Data-input functions always are enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.



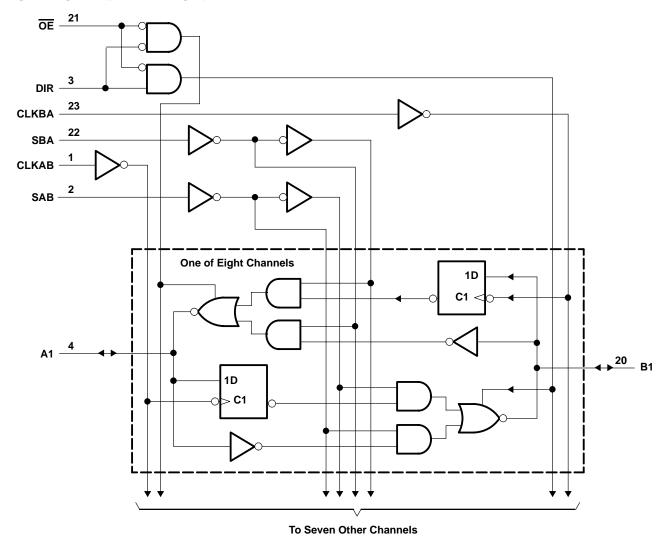


Pin numbers shown are for the DW, JT, NT, and W packages.

Figure 1. Bus-Management Functions



logic diagram (positive logic)



Pin numbers shown are for the DW, JT, NT, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) (see Note 1)	
Continuous output current, I_O ($V_O = 0$ to V_{CC})	
Continuous current through V _{CC} or GND	±70 mA
Package thermal impedance, θ _{JA} (see Note 2): DW package	46°C/W
(see Note 3): NT package	67°C/W
Storage temperature range, T _{stg}	. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The package thermal impedance is calculated in accordance with JESD 51-7.
 - 3. The package thermal impedance is calculated in accordance with JESD 51-3.



recommended operating conditions (see Note 4)

			SN	54HCT6	46	SN	74HCT6	46	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	V _{CC} = 4.5 V to 5.5 V	2		15	2			V
VIL	Low-level input voltage	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		PA PA	0.8			0.8	V
٧I	Input voltage		0	7	Vcc	0		Vcc	V
٧o	Output voltage		0	5	VCC	0		VCC	V
t _t	Input transition (rise and fall) time		Ó	7	500			500	ns
TA	Operating free-air temperature		-55		125	-40		85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DA.	RAMETER	TEST CO	NDITIONS	Vaa	Т	A = 25°C	;	SN54H	CT646	SN74H	CT646	UNIT
FA	RAMETER	1231 00	NDITIONS	VCC MIN TYP MAX		MAX	MIN	MAX	MIN	MAX	UNIT	
Vон		VI = VIH or VIL	$I_{OH} = -20 \mu A$	4.5 V	4.4	4.499		4.4		4.4		V
VOH		AL = AIH OLAIL	$I_{OH} = -6 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		V
V0:		\\. = \\ or \\	$I_{OL} = 20 \mu A$	4.5 V		0.001	0.1		0.1		0.1	V
VOL		$V_I = V_{IH}$ or V_{IL}	$I_{OL} = 6 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	V
Ιį	Control inputs	$V_I = V_{CC}$ or 0	5.5 V		±0.1	±100		±1000		±1000	nA	
loz	A or B	$V_O = V_{CC}$ or 0		5.5 V		±0.01	±0.5	4	±10		±5	μΑ
Icc		$V_I = V_{CC}$ or 0,	I _O = 0	5.5 V			8	372	160		80	μΑ
∆lcc†		One input at 0.5 V or 2.4 V, Other inputs at 0 or V _{CC}		5.5 V		1.4	2.4	Ody	3		2.9	mA
Ci	Control inputs			4.5 V to 5.5 V		3	10		10		10	pF

[†] This is the increase in supply current for each input that is at one of the specified TTL voltage levels, rather than 0 V or V_{CC}.

timing requirements over recommended operating free-air temperature range (unless otherwise noted)

		Vaa	T _A = 2	25°C	SN54H	CT646	SN74HCT646		UNIT
		Vcc	MIN	MAX	MIN	MAX	MIN	MAX	ONIT
f., .	Clock frequency	4.5 V		31		22		27	MHz
fclock	Clock frequency	5.5 V		36		24		29	IVII IZ
	t _w Pulse duration, CLKBA or CLKAB high or low		16		23	EV.	19		ns
t _W	Pulse duration, CENDA of CENAB high of low	5.5 V	14		21	Q'	17		110
Ţ.	Output time A hadron Olikapit and badron Olikapit	4.5 V	20		30		25		ns
t _{su}	Setup time, A before CLKAB↑ or B before CLKBA↑	5.5 V	18		27		23		115
<u>+.</u>	Halding A grow Olivaph and a read Olivaph		5		5		5		no
th	Hold time, A after CLKAB↑ or B after CLKBA↑	5.5 V	5		5		5	·	ns

SN54HCT646, SN74HCT646 **OCTAL BUS TRANSCEIVERS AND REGISTERS** WITH 3-STATE OUTPUTS

SCLS178C - MARCH 1984 - REVISED MARCH 2003

switching characteristics over recommended operating free-air temperature range, C_L = 50 pF (unless otherwise noted) (see Figure 2)

PARAMETER	FROM	то	V	T,	4 = 25°C	;	SN54H	CT646	SN74H	CT646	UNIT
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
•			4.5 V	31	54		22		27		MHz
f _{max}			5.5 V	36	64		24		29		IVII IZ
	CLKBA or CLKAB	A or B	4.5 V		18	36		54		45	
	CLNBA OF CLNAB	AOIB	5.5 V		16	32		49		41	
	A or B	B or A	4.5 V		14	27		41		34	no
^t pd	AUID	D OI A	5.5 V		12	24		37		31	ns
	004 045 [‡]	A or B	4.5 V		20	38		57		48	
	SBA or SAB†	AUID	5.5 V		17	34		51		43	
		A or B	4.5 V		25	49		74		61	no
^t en	ŌĒ	AUIB	5.5 V		22	44	Ć	67		55	ns
.	ŌĒ	A or B	4.5 V		25	49	q_{Q}	74		61	ns
^t dis	OE	AUIB	5.5 V		22	44	d's	67		55	115
	DIR	A or B	4.5 V		25	49		74		61	20
^t en	DIK	AUID	5.5 V		22	44		67		55	ns
4	DIR	A or B	4.5 V		25	49		74		61	no
^t dis	DIR	AUID	5.5 V		22	44		67		55	ns
4.		Any	4.5 V		9	12		18		15	no
t _t		Any	5.5 V		7	11		16		14	ns

[†] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

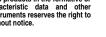
switching characteristics over recommended operating free-air temperature range, C_L = 150 pF (unless otherwise noted) (see Figure 2)

DADAMETED	FROM	то	V	TA	√ = 25°C	;	SN54HCT	646	SN74H	CT646	LIAUT	
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN I	MAX	MIN	MAX	UNIT	
	CLKBA or CLKAB	A or B	4.5 V		24	53		80		66		
^t pd	CLNDA OI CLNAD	AUID	5.5 V		22	47		52		60	l	
	A or B	B or A	4.5 V		22	44		67		55	20	
	AUIB	BUIA	5.5 V		20	39	á	60		50	ns	
	004 04Dt	A or B	4.5 V		26	55	'Q'	83		69		
	SBA or SAB†	AUIB	5.5 V		24	49	1	74		62		
		A or B	4.5 V		33	66	2	100		87		
+	ŌĒ	AUID	5.5 V		22	59	0,0	90		74	no	
^t en	DIR	A or B	4.5 V		33	66	Q	100		87	ns	
	DIK	AUIB	5.5 V		22	59		90		74		
4.		Any	4.5 V		17	42		63		53	no	
t _t		Any	5.5 V		14	38		57		48	ns	

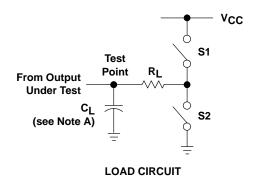
[†] These parameters are measured with the internal output state of the storage register opposite that of the bus input.

operating characteristics, T_A = 25°C

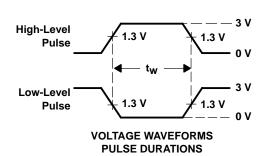
	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load	50	pF

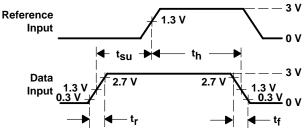


PARAMETER MEASUREMENT INFORMATION

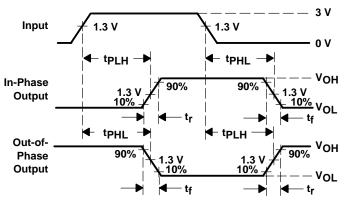


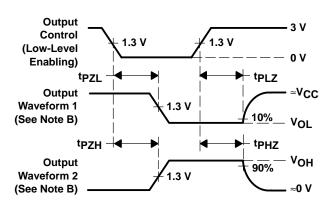
PARAI	METER	RL	CL	S1	S2
	tPZH	1 k Ω	50 pF or	Open	Closed
ten t	tPZL	1 K22	150 pF	Closed	Open
	tPHZ 1 kΩ 50 pF		Open	Closed	
^t dis	tPLZ	1 K22	30 pr	Closed	Open
t _{pd} or	tpd or tt		50 pF or 150 pF	Open	Open





VOLTAGE WAVEFORMS
SETUP AND HOLD AND INPUT RISE AND FALL TIMES





VOLTAGE WAVEFORMS
PROPAGATION DELAY AND OUTPUT RISE AND FALL TIMES

VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES FOR 3-STATE OUTPUTS

NOTES: A. C_L includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_f = 6 ns.
- D. For clock inputs, f_{max} is measured when the input duty cycle is 50%.
- E. The outputs are measured one at a time with one input transition per measurement.
- F. tpl 7 and tpH7 are the same as tdis.
- G. tpzL and tpzH are the same as ten.
- H. tpLH and tpHL are the same as tod.

Figure 2. Load Circuit and Voltage Waveforms





PACKAGE OPTION ADDENDUM

10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
							(6)				
SN74HCT646DW	ACTIVE	SOIC	DW	24	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	HCT646	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

DW (R-PDSO-G24)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AD.



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

Tl's products are provided subject to Tl's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such Tl products. Tl's provision of these resources does not expand or otherwise alter Tl's applicable warranties or warranty disclaimers for Tl products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2020, Texas Instruments Incorporated